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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/585,128	06/30/2006	Koichiro Tanaka	0756-7726	9907
	7590 03/16/201 ectual Property Law O		EXAM	INER
3975 Fair Ridge	75 Fair Ridge Drive GARCIA, JOANNIE A			OANNIE A
Suite 20 North Fairfax, VA 220	033		ART UNIT PAPER NUMBER	
		2895		
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Please find below and/or attached an Office communication concerning this application or proceeding.

The time period for reply, if any, is set in the attached communication.

	Application No.	Applicant(s)	
Office Action Occurs	10/585,128	TANAKA ET AL.	
Office Action Summary	Examiner	Art Unit	
	JOANNIE A. GARCIA	2895	
The MAILING DATE of this communication app Period for Reply	ears on the cover sheet with the c	orrespondence address -	-
A SHORTENED STATUTORY PERIOD FOR REPLY WHICHEVER IS LONGER, FROM THE MAILING DA - Extensions of time may be available under the provisions of 37 CFR 1.13 after SIX (6) MONTHS from the mailing date of this communication. - If NO period for reply is specified above, the maximum statutory period w - Failure to reply within the set or extended period for reply will, by statute, Any reply received by the Office later than three months after the mailing earned patent term adjustment. See 37 CFR 1.704(b).	ATE OF THIS COMMUNICATION 6(a). In no event, however, may a reply be time fill apply and will expire SIX (6) MONTHS from cause the application to become ABANDONEI	l. ely filed he mailing date of this communica) (35 U.S.C. § 133).	
Status			
 1) ☐ Responsive to communication(s) filed on 22 Fe 2a) ☐ This action is FINAL. 2b) ☐ This 3) ☐ Since this application is in condition for allowant closed in accordance with the practice under E 	action is non-final. nce except for formal matters, pro		s is
Disposition of Claims			
4) ☐ Claim(s) 14-39 is/are pending in the application 4a) Of the above claim(s) is/are withdraw 5) ☐ Claim(s) is/are allowed. 6) ☐ Claim(s) 14-23,25-35 and 37-39 is/are rejected 7) ☐ Claim(s) 24 and 36 is/are objected to. 8) ☐ Claim(s) are subject to restriction and/or	vn from consideration.		
Application Papers			
9) The specification is objected to by the Examiner 10) The drawing(s) filed on is/are: a) access applicant may not request that any objection to the of Replacement drawing sheet(s) including the correction and the original transfer of the second sheet and the second sheet are sheet as a second sheet and the second sheet are sheet as a second sheet and the second sheet are sheet as a second sheet are sheet as a second sheet and the second sheet are sheet as a second sheet and the second sheet are sheet as a second sheet and the second sheet are sheet as a second sheet as a second sheet are sheet as a second sheet are sheet as a second sheet are sheet as a second sheet as a second sheet as a second sheet are sheet as a second sheet as	epted or b) objected to by the Edrawing(s) be held in abeyance. See on is required if the drawing(s) is obj	37 CFR 1.85(a). ected to. See 37 CFR 1.12	
Priority under 35 U.S.C. § 119			
 12) Acknowledgment is made of a claim for foreign a) All b) Some * c) None of: 1. Certified copies of the priority documents 2. Certified copies of the priority documents 3. Copies of the certified copies of the prior application from the International Bureau * See the attached detailed Office action for a list of 	s have been received. s have been received in Applicati ity documents have been receive (PCT Rule 17.2(a)).	on No d in this National Stage	
Attachment(s) 1) Notice of References Cited (PTO-892)	4) Interview Summary		
Notice of Draftsperson's Patent Drawing Review (PTO-948) Information Disclosure Statement(s) (PTO/SB/08) Paper No(s)/Mail Date	Paper No(s)/Mail Da 5) Notice of Informal P 6) Other:		

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Claim Rejections - 35 USC § 103

The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.

Claims 14-23, 25-35, and 37-39, are rejected under 35 U.S.C. 103(a) as being unpatentable over Sasaki et al (US 2003/0216012 A1), and further in view of Tanaka et al'223 (US 2004/0266223 A1), Tanaka et al'182 (US 2003/0086182 A1), Sawada et al (US 2006/0138102 A1), and the following comments.

Regarding claims 14 and 26, Sasaki et al discloses a method for manufacturing a semiconductor device comprising forming a semiconductor film 36 over a substrate 12 (Figures 6 and 22, and Paragraphs 0069 and 0132), blocking end portions of a first laser beam emitted from a laser oscillator 71 by a lens 76 to produce a second laser beam (Figure 22, and Paragraph 0133), producing the second laser beam into a third laser beam by using a condensing lens 77 (Figure 22, and Paragraph 0133), irradiating the semiconductor film with the third laser beam, and moving the third laser beam relative to the semiconductor film (Figure 22, and Paragraphs 0018, and 0135-0137).

Also regarding claims 14 and 26, Sasaki et al does not teach blocking end portions of the first laser beam emitted from the laser oscillator 71 by a slit to produce a second laser beam. Tanaka et al'223 discloses blocking end portions of a first laser beam emitted from a laser oscillator 1101 by a slit or lens to produce a second laser beam (Figures 1A, 1B, 3A, and 3B, and Paragraphs 0031, 0037, 0038, 0061-0066,

0080, and 0084). It would have been obvious to one of ordinary skill in the art to combine the teachings of Sasaki et al and Tanaka et al'223, to enable blocking end portions of the first laser beam emitted from the laser oscillator 71 of Sasaki et al to be performed, to produce a second laser beam by using a slit or lens, according to the teachings of Tanaka et al'223, because in such process, the method of Tanaka et al'223, would be used according to its disclosed intended purpose and would therefor have reasonably been expected by one of ordinary skill in the art to yield the predictable results of blocking end portions of the first laser beam emitted from the laser oscillator 71 to produce a second laser beam by using a slit or lens in the process of Sasaki et al, and also, it would improve an operating characteristic and reliability of a semiconductor device (See Tanaka et al'223, Paragraph 0039).

Regarding claims 15 and 27, Sasaki et al discloses a method for manufacturing a semiconductor device comprising forming a semiconductor film 36 over a substrate 12 (Figures 6 and 22, and Paragraphs 0069 and 0132), combining a first laser beam emitted from a first laser oscillator 71 whose polarizing direction has been changed by a waveplate 78 with a second laser beam emitted from a second laser oscillator 72 by a polarizer 80, the combined laser beam serving as a third laser beam (Figure 22 and Paragraphs 0132 and 0134), blocking end portions of the third laser beam by a slit 76 to produce a fourth laser beam (Figure 22, and Paragraph 0133), producing the fourth laser beam into a fifth laser beam by using a condensing lens 77 (Figure 22, and Paragraph 0133), irradiating the semiconductor film with the fifth laser beam, and

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moving the fifth laser beam relative to the semiconductor film (Paragraphs 018, and 0135-0137).

Also regarding claims 15 and 27, Sasaki et al does not teach blocking end portions of the first laser beam emitted from the laser oscillator 71 by a slit to produce a second laser beam. Tanaka et al'223 discloses blocking end portions of a first laser beam emitted from a laser oscillator 1101 by a slit or lens to produce a second laser beam (Figures 1A, 1B, 3A, and 3B, and Paragraphs 0031, 0037, 0038, 0061-0066, 0080, and 0084). It would have been obvious to one of ordinary skill in the art to combine the teachings of Sasaki et al and Tanaka et al'223, to enable blocking end portions of the first laser beam emitted from the laser oscillator 71 of Sasaki et al to be performed, to produce a second laser beam by using a slit or lens, according to the teachings of Tanaka et al'223, because in such process, the method of Tanaka et al'223, would be used according to its disclosed intended purpose and would therefor have reasonably been expected by one of ordinary skill in the art to yield the predictable results of blocking end portions of the first laser beam emitted from the laser oscillator 71 to produce a second laser beam by using a slit or lens in the process of Sasaki et al, and also, it would improve an operating characteristic and reliability of a semiconductor device (See Tanaka et al'223, Paragraph 0039).

Regarding claims 16 and 28, Sasaki et al discloses that the condensing lens is a convex spherical lens (Paragraph 0133).

Regarding claims 17 and 29, Sasaki et al discloses that the laser beam is a continuous wave laser beam (Paragraph 0132).

Regarding claims 25 and 37, Sasaki et al discloses that an image at the slit and an image on the irradiation surface are in a conjugated relation by the condensing lens (Figure 22, and Paragraph 0132-0134).

Regarding claims 18, 21, 22, 30 and 33, Sasaki et al does not teach that the laser beam is emitted from a YAG laser, YVO₄ laser, YAlO₃ laser, an alexandrite laser, a Ti:sapphire laser, an Ar gas laser, or a Kr gas laser, with a repetition rate of more than 10 MHz Tanaka et al discloses a laser beam emitted from a YAG laser, YVO₄ laser, YAlO₃ laser, an alexandrite laser, a Ti:sapphire laser, an Ar gas laser, or a Kr gas laser (Paragraphs 0018, 0023, 0027, 0106, 0109, and 0110). It would have been obvious to one of ordinary skill in the art to combine the teachings of Sasaki et al and Tanaka et al, to enable the laser beam 71 and 72 of Sasaki et al to be performed, according to the teachings of Tanaka et al, because in such a process the method of Tanaka et al would be used according to it's disclosed intended purpose and would therefor have reasonably been expected by one of ordinary skill in the art to yield the predictable results of achieving the laser beams 71 and 72 of Sasaki et al, and also, it would improve crystallinity (See Tanaka et al, Paragraph 0011).

Regarding claims 19, 20, 31 and 32, Sasaki et al does not teach that the laser beam has a pulse width in femtoseconds, and that the laser beams if a Ti:sapphire laser. Sawada et al discloses a laser beam having a pulse width in femtoseconds, and that the laser beams is a Ti:sapphire laser (Paragraphs 0008, 0048, and 0058). It would have been obvious to one of ordinary skill in the art to combine the teachings of Sasaki et al and Sawada et al, to enable the laser beam 71 and 72 of Sasaki et al to be

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performed, according to the teachings of Tanaka et al, because in such a process the method of Sawada et al would be used according to it's disclosed intended purpose and would therefor have reasonably been expected by one of ordinary skill in the art to yield the predictable results of achieving the laser beams 71 and 72 of Sasaki et al, and also, it would provide a suitable method for processing small parts such as those for a micromachine (See Sawada et al, Paragraph 0058).

Regarding claims 23 and 35, Sasaki et al discloses the claimed invention except for a width of a microcrystal region to a laser irradiation region formed by the laser irradiation apparatus ranges from 1 to 20 pm. It would have been obvious to one having ordinary skill in the art at the time the invention was made to determine suitable width for the microcrystal region in the process of Sasaki et al to be performed, since it has been held that where the general conditions of a claim are disclosed in the prior art, discovering the optimum or workable ranges involves only routine skill in the art. *In re Aller*,105 USPQ 233.

In addition, the selection of the suitable width, it's obvious because it is a matter of determining optimum process conditions by routine experimentation with a limited number of species of result effective variables. These claims are prima facie obvious without showing that the claimed ranges achieve unexpected results relative to the prior art range. In re Woodruff, 16 USPQ2d 1935, 1937 (Fed. Cir. 1990). See also In re Huang, 40 USPQ2d 1685, 1688 (Fed. Cir. 1996)(claimed ranges or a result effective variable, which do not overlap the prior art ranges, are unpatentable unless they produce a new and unexpected result which is different in kind and not merely in degree

from the results of the prior art). See also In re Boesch, 205 USPQ 215 (CCPA) (discovery of optimum value of result effective variable in known process is ordinarily within skill or art) and In re Aller, 105 USPQ 233 (CCPA 1995) (selection of optimum ranges within prior art general conditions is obvious).

Note that the specification contains no disclosure of either the critical nature of the claimed suitable width, or any unexpected results arising therefrom. Where patentability it's said to be based upon particular chosen suitable widths, or upon another variable recited in a claim, the Applicant must show that the chosen suitable widths, are critical. *In re Woodruf*, 919 F.2d 1575, 1578, 16 USPQ2d 1934, 1936 (Fed. Cir. 1990).

Regarding claims 38 and 39, Sasaki et al discloses wherein the polarizing direction of the first laser beam has been changed by a waveplate 81 (Figure 22).

Response to Arguments

Applicant argues that Sasaki et al does not teach blocking end portions of a first laser beam emitted from a laser oscillator by a slit to produce a second laser beam. However, Sasaki et al is not relied upon for that purpose. Tanaka et al'223 is relied instead for that purpose by disclosing blocking end portions of a first laser beam emitted from a laser oscillator 1101 by a slit or lens to produce a second laser beam (Figures 1A, 1B, 3A, and 3B, and Paragraphs 0031, 0037, 0038, 0061-0066, 0080, and 0084), and therefore, it would have been obvious to one of ordinary skill in the art to combine the teachings of Sasaki et al and Tanaka et al'223, to enable blocking end portions of

the first laser beam emitted from the laser oscillator 71 of Sasaki et al to be performed, to produce a second laser beam by using a slit or lens, according to the teachings of Tanaka et al'223, because in such process, the method of Tanaka et al'223, would be used according to its disclosed intended purpose and would therefor have reasonably been expected by one of ordinary skill in the art to yield the predictable results of blocking end portions of the first laser beam emitted from the laser oscillator 71 to produce a second laser beam by using a slit or lens in the process of Sasaki et al.

Allowable Subject Matter

Claim 24 and 36 are objected to as being dependent upon a rejected base claim, but would be allowable if rewritten in independent form including all of the limitations of the base claim and any intervening claims.

Conclusion

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Joannie García, whose telephone number is (571) 272-1861. The examiner can normally be reached on Monday through Friday, 8:30 A.M. to 5:00 P.M.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, N. Drew Richards, can be reached on (571) 272-1736. The fax phone number for the organization where this application or proceeding is assigned is 571-

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273-8300.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

/N. Drew Richards/ Supervisory Patent Examiner, Art Unit 2895

/JAG/ March 10, 2011

DRichards SPE